



# kester®

Technical Data Sheet

## 186 FLUX-PEN®

Mildly Activated Rosin Flux-Pen® for Lead-bearing and Lead-free Alloys



### Product Description

Kester 186 Flux-Pen® is specifically designed for leaded and lead-free rework of conventional and surface mount circuit board assemblies. 186 Flux-Pen® under MIL-F-14256, was QPL approved as Type RMA. Although the fluxing ability approaches that of Type RA flux, residues after soldering are non-corrosive and non-conductive. 186 Flux-Pen® has been developed for use in critical applications where difficult assemblies are to be soldered, but process requirements stipulate use of Type RMA flux. 186 Flux-Pen® possess high thermal stability for soldering multi-layer assemblies which require higher temperatures. Exposure to high preheat temperatures does not degrade solubility of the residue in normal cleaning solvents. There is no surface insulation resistance degradation caused by the flux residue. The use of a minimum of ionic activating agents and the inactive nature of the residue permits leaving the residue on circuit board assemblies for many applications. The flux residue is also moisture and fungus resistant.

### Performance Characteristics:

- High thermal stability
- Improves soldering performance
- Eliminates the need and expense of cleaning
- Classified as ROL0 per J-STD-004 & J-STD-004B



### RoHS Compliance

This product meets the requirements of the Restriction of Hazardous Substances (RoHS) Directive. Additional RoHS information is located at <https://www.kester.com/downloads/environmental>.



### Physical Properties

**Specific Gravity:** 0.879  
Anton Paar DMA @ 25°C

**Percent Solids (theoretical):** 36%  
IPC-TM-650, Method 2.3.34

**Acid Number (typical):** 55 mg KOH/g  
flux  
IPC-TM-650, Method 2.3.13

**Flash Point:** 18°C (64°F)



### Reliability Properties

**Copper Mirror Corrosion:** Low  
IPC-TM-650, Method 2.3.32

**Chloride and Bromides:** 0.02%  
IPC-TM-650, Method 2.3.35

**Surface Insulation Resistivity (SIR):**  
Pass  
IPC-TM-650, Method 2.6.3.7

**Corrosion Test:** Low  
IPC-TM-650, Method 2.6.15

**Electrochemical Migration (ECM):**  
Pass  
IPC-TM-650 Method 2.6.14.1 [65°C, 85% RH,  
100V, 21days]

**Surface Insulation Resistivity (SIR):**  
Pass  
IPC-TM-650, Method 2.6.3.3

**Silver Chromate:** Pass  
IPC-TM-650, Method 2.3.33



## Flux Application

186 Flux-Pen® is applied to circuit boards via Flux-Pen® for rework of printed wire assemblies.



## Process Considerations

186 Flux-Pen® should only be applied to areas that will be fully heated by the soldering iron or other reflow tool. Care should be taken to avoid flooding the assembly. The surface tension has been adjusted to help the flux form a thin film on the board surface allowing rapid solvent evaporation.



## Cleaning

186 Flux-Pen® flux residues are non-conductive, non-corrosive and do not require removal in most applications.



## Storage, Handling and Shelf Life

186 Flux-Pen® is flammable. Store away from sources of ignition. Shelf life is 2 years from date of manufacture when handled properly and held at 10-25°C (50-77°F). The cap must be in place when not being used.



## Health and Safety

This product, during handling or use, may be hazardous to your health or the environment. Read the Safety Data Sheet and warning label before using this product.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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